IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Y. SHIMADA, et al.

Serial No: 10/521,470

Filed: January 18, 2005

Title: MULTILAYER WIRING BOARD, MANUFACTURING METHOD

THEREOF; SEMICONDUCTOR DEVICE, AND WIRELESS

ELECTRONIC DEVICE

Group: 2818

Examiner: Phuc T. DANG Confirmation No.: 2249

<u>AMENDMENT</u>

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

August 10, 2006

Sir:

In response to the Office Action mailed July 10, 2006, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Claims; and

Remarks are included following the amendments.